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SMF5.0A - SMF100A Taiwan Semiconductor

200W, 5V - 100V Surface Mount Transient Voltage Suppressor

FEATURES

TAIWAN

• Photo Glass passivated junction

CONDUCTOR

- Low power loss, high efficiency
- Ideal for automated placement
- Excellent clamping capability
- Typical $I_{\rm R}$ less than 1µA above 10V
- 200 watts peak pulse power capability with a 10 / 1000 μs waveform (V_{WM} \geq 60V, P_{PPM} = 175W)
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

MECHANICAL DATA

- Case: SOD-123W
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 16 mg (approximately)

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
SYMBOL	VALUE	UNIT			
P _{PPM}	200	W			
P _{tot}	1	W			
V _F	3.5	V			
TJ	-55 to +175	°C			
T _{STG}	-55 to +175	°C			
	SYMBOL P _{PPM} P _{tot} V _F T _J	SYMBOL VALUE PPPM 200 Ptot 1 VF 3.5 TJ -55 to +175			

Notes:

- 1. Non-repetitive Current Pulse Per Fig. 3 and derated above TA=25°C Per Fig. 2
- 2. Units mounted on recommended PCB (5mm x 5mm Cu pad test board)
- 3. Pulse test with PW=0.3 ms

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
V _{WM}	5 - 100	V		
V _{BR} (uni-directional)	6.8 - 117	V		
P _{PPM}	200	W		
T _{J MAX}	175	°C		
Package	SOD-123W			
Configuration	Sing	le		





SOD-123W



THERMAL PERFORMANCE

PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-lead thermal resistance per diode	R _{ejl}	33	°C/W
Junction-to-ambient thermal resistance per diode	R _{eja}	100	°C/W
Junction-to-case thermal resistance per diode	R _{eJC}	34	°C/W

Thermal Performance Note: Units mounted on recommended PCB (5mm x 5mm Cu pad test board)

ELECTR	ICAL S	PECI	FICA ⁻	TIONS (Γ _A = 25°C u	nless otherwise n	oted)	
Part	Marking	vol	kdown tage	Test	Working stand-off	Maximum reverse leakage	Maximum peak impulse current	Maximum clamping voltage
number	code		,@I _⊺	current	voltage	current	I _{PPM}	V _C @I _{PPM}
		(V)	Ι _Τ	-	I _R @V _{WM}	(A)	(V)
		(No	ote 1)	(mA)	V _{WM}	(μA)		
Uni.	Uni.	Min.	Max.		(V)	(Note 1)	tp =10/1000 μs	tp =10/1000 μs
SMF5.0A	2W5P0	6.4	7.0	10	5	800	21.7	9.2
SMF6.0A	2W6P0	6.67	7.37	10	6	800	19.4	10.3
SMF6.5A	2W6P5	7.22	7.98	10	6.5	500	17.9	11.2
SMF7.0A	2W7P0	7.78	8.6	10	7.0	200	16.7	12.0
SMF7.5A	2W7P5	8.33	9.21	1	7.5	100	15.5	12.9
SMF8.0A	2W8P0	8.89	9.83	1	8.0	50	14.7	13.6
SMF8.5A	2W8P5	9.44	10.5	1	8.5	10	13.9	14.4
SMF9.0A	2W9P0	10.0	11.1	1	9.0	5	13.0	15.4
SMF10A	2W010	11.1	12.3	1	10	5	11.8	17.0
SMF11A	2W011	12.2	13.5	1	11	1	11.0	18.2
SMF12A	2W012	13.3	14.7	1	12	1	10.1	19.9
SMF13A	2W013	14.4	15.9	1	13	1	9.3	21.5
SMF14A	2W014	15.6	17.2	1	14	1	8.6	23.2
SMF15A	2W015	16.7	18.5	1	15	1	8.2	24.4
SMF16A	2W016	17.8	19.7	1	16	1	7.7	26.0
SMF17A	2W017	18.9	20.9	1	17	1	7.2	27.6
SMF18A	2W018	20.0	22.1	1	18	1	6.8	29.2
SMF20A	2W020	22.2	24.5	1	20	1	6.2	32.4
SMF22A	2W022	24.4	26.9	1	22	1	5.6	35.5
SMF24A	2W024	26.7	29.5	1	24	1	5.1	38.9
SMF26A	2W026	28.9	31.9	1	26	1	4.8	42.1
SMF28A	2W028	31.1	34.4	1	28	1	4.4	45.4
SMF30A	2W030	33.3	36.8	1	30	1	4.1	48.4
SMF33A	2W033	36.7	40.6	1	33	1	3.8	53.3
SMF36A	2W036	40.0	44.2	1	36	1	3.4	58.1
SMF40A	2W040	44.4	49.1	1	40	1	3.1	64.5
SMF43A	2W043	47.8	52.8	1	43	1	2.9	69.4
SMF45A	2W045	50.0	55.3	1	45	1	2.8	72.7
SMF48A	2W048	53.3	58.9	1	48	1	2.6	77.4
SMF51A	2W051	56.7	62.7	1	51	1	2.4	82.4
SMF54A	2W054	60.0	66.3	1	54	1	2.3	87.1
SMF58A	2W058	64.4	71.2	1	58	1	2.1	95
SMF60A	2W060	66.7	73.7	1	60	1	1.8	96.8
SMF64A	2W064	71.1	78.6	1	64	1	1.7	103
SMF70A	2W070	77.8	86	1	70	1	1.55	113
SMF75A	2W075	83.3	92.1	1	75	1	1.45	121
SMF78A	2W078	86.7	95.8	1	78	1	1.4	126
SMF85A	2W085	94.4	104	1	85	1	1.3	137
SMF90A	2W090	100	111	1	90	1	1.05	146
SMF100A	2W100	111	123	1	100	1	1.08	162

Note:

1. Pulse test with PW=30 ms



ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX(*)	PACKING Code	PACKING CODE SUFFIX	PACKAGE	PACKING
SMFxxxA		RV	G	SOD-123W	3,000 / 7" Reel
(Note 1,2)	H	RQ		SOD-123W	10,000 / 13" Reel

Notes :

1. "xxx" defines voltage from 5V (SMF5.0A) to 100V (SMF100A)

2. Whole series with green compound (halogen-free)

*: Optional available

EXAMPLE					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
SMF5.0AHRVG	SMF5.0A	Н	RV	G	AEC-Q101 qualified Green compound



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Pulse Power or Current vs. Initial Junction

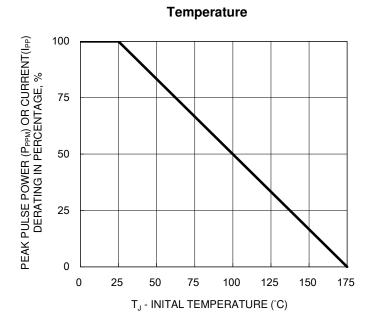


Fig.2 Steady State Power Derating

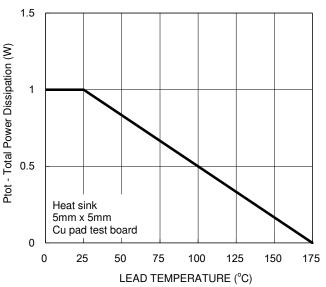
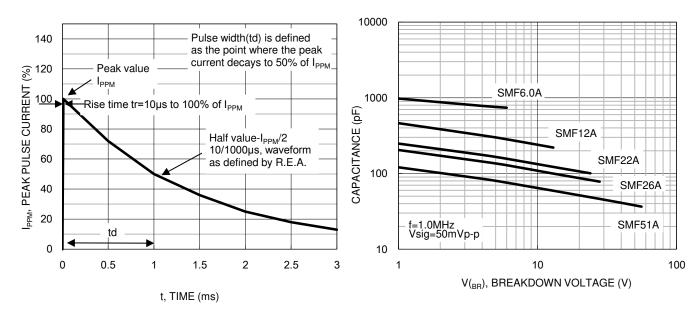


Fig.3 Clamping Power Pulse Waveform

Fig.4 Typical Junction Capacitance

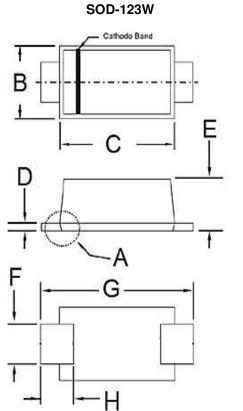


SMF5.0A - SMF100A Taiwan Semiconductor



PACKAGE OUTLINE DIMENSIONS

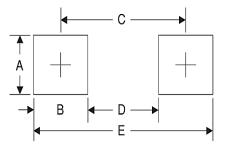
5 TAIWAN SEMICONDUCTOR



DIM.	Unit	(mm)	Unit (inch)	
	Min	Max	Min	Max
В	1.70	1.90	0.067	0.075
С	2.60	2.90	0.102	0.114
D	0.10	0.22	0.004	0.009
E	0.90	1.02	0.035	0.040
F	0.90	1.05	0.035	0.041
G	3.60	3.80	0.142	0.150
Н	0.50	0.85	0.020	0.033
I	0.00	0.10	0.000	0.004



SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	1.4	0.055
В	1.2	0.047
С	3.1	0.122
D	1.9	0.075
E	4.3	0.169

MARKING DIAGRAM



P/N	=Marking Code
YW	=Date Code
F	=Factory Code

=Factory Code



Taiwan Semiconductor

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